









Release Date: 01 March 2016 Version: A1.0

PRODUCT DATASHEET



- ► PLCC2 SMD
- ➤ 3528 1.9t Series
- ➤ Warm White (3000K)

N0W28S50







2835 1.9t Series

APPLICATIONS:

- **General Lighting**
- Portable Lighting
- Commercial Lighting
- **Indoor Lighting**
- Backlight for LCD

2835 1.9t Series

FEATURES:

- Package: PLCC2 White SMD Package
- Forward Current: 20mA Forward Voltage (typ.): 3.2V
- Luminous Intensity (typ.): 2450mcd@20mA
- Colour: Warm White
- Colour Temperature (CCT): 3000K
- Viewing angle: 120°
- **Materials:**
 - Die: InGaN
 - Resin: Silicon (Yellow Diffused)
 - L/T Finish: Ag plated
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- **Grouping parameters:**
 - Forward Voltage
 - **Luminous Intensity**
 - **CIE Chromaticity**
- Soldering methods: Reflow Soldering
- Preconditioning: MSL3 according to JEDEC
- Packing: 8mm tape with 2000/reel, ø180mm (7")



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	30	mA
Pulse Forward Current (Duty 1/10, width 0.1ms)	I _{PF}	100	mA
Reverse Voltage	V_R	5	V
Reverse Current @5V	I _R	10	μΑ
Junction Temperature	Tj	110	°C
Electrostatics Discharge	ESD	1000	V
Operating Temperature	T _{OPR}	-40~+85	°C
Storage Temperature	T _{STG}	-40~+100	°C
Soldering Temperature	T _{SOL}	260	°C
Colour Rendering Index	CRI	80	

Electrical & Optical Characteristics (Ta=25°C)

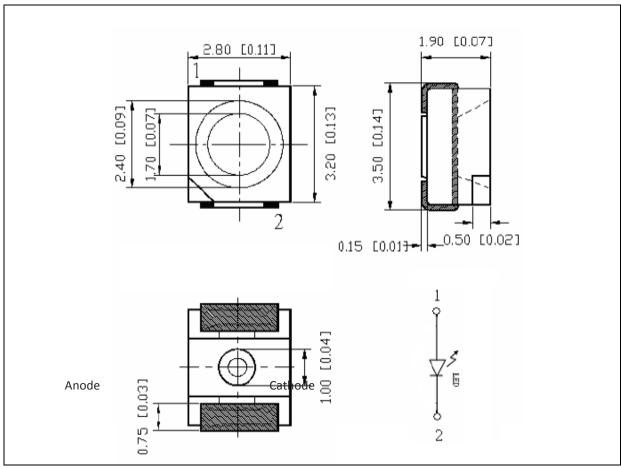
Darameter	Cumbal	Values			Unit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Offic	Condition	
Forward Voltage	V_{F}	2.8	3.2	3.6	V	I _F =20mA	
Luminous Intensity	I _V	2050	2450	2850	mcd	I _F =20mA	
Chromaticity	Х		0.4403			1 20m A	
Coordinates	Υ		0.4043			I _F =20mA	
Colour Temperature	ССТ	2760	2960	3160	К	I _F =20mA	
Viewing Angle	2θ _{1/2}		120		deg	I _F =20mA	

^{1.} Luminous Intensity (Φ_V) ±10%, Forward Voltage (V_F) ±0.1V



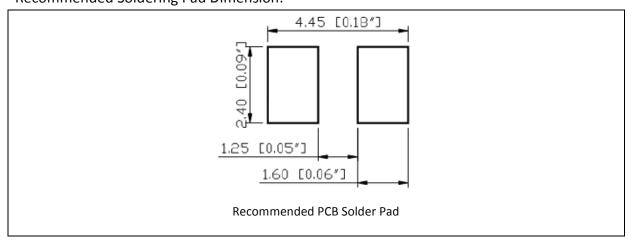
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.1 mm with angle tolerance $\pm 0.5^{\circ}$.



BINNING GROUPS:

Forward Voltage Classifications ($I_F = 20mA$):

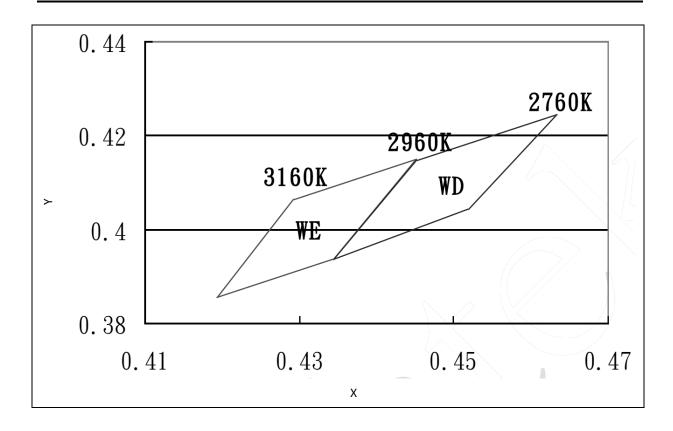
Code	Min.	Max.	Unit
В	2.8	2.9	
С	2.9	3.0	
D	3.0	3.1	
E	3.1	3.2	V
F	3.2	3.3	V
G	3.3	3.4	
Н	3.4	3.5	
I	3.5	3.6	

Luminous Intensity Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
6	2050	2250	
7	2250	2450	mad
8	2450	2650	mcd
9	2650	2850	



CIE CHROMATICITY DIAGRAM:

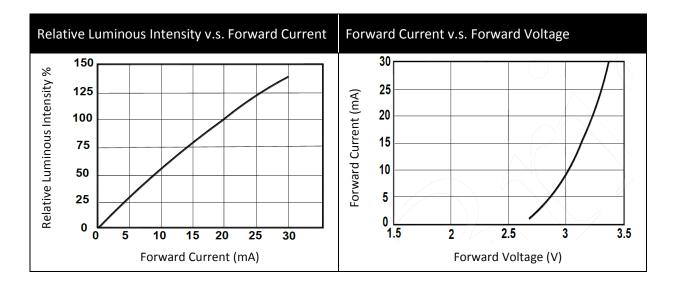


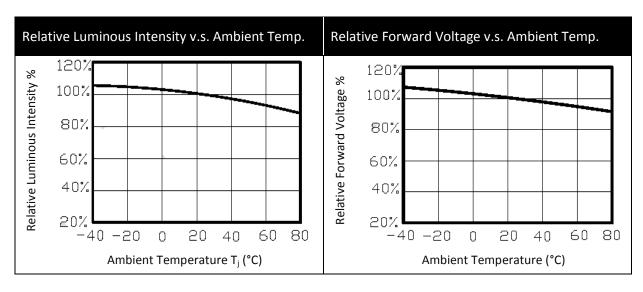
Chromaticity Coordinates Classifications (I_F = 20mA):

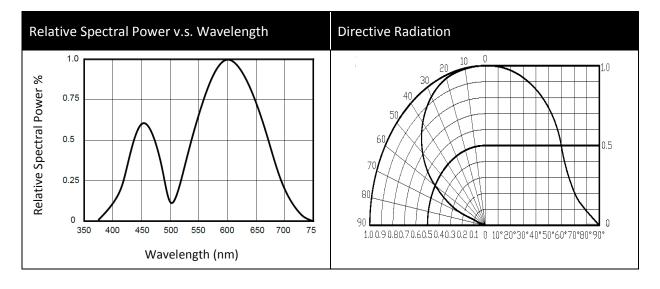
	1	1	2		3		4	
	Х	Υ	Х	Υ	Х	Υ	Х	Υ
WE	0.4249	0.4064	0.4193	0.3855	0.4344	0.3937	0.4451	0.4149
WD	0.4451	0.4147	0.4344	0.3937	0.4519	0.4044	0.4633	0.4245



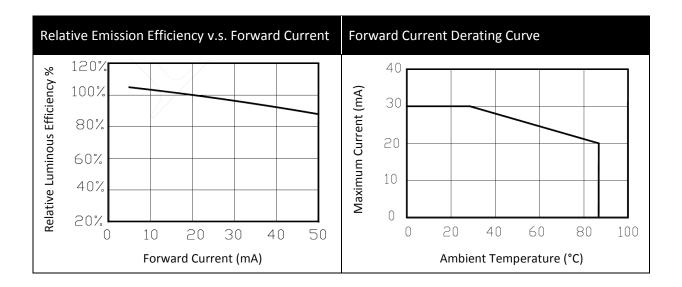
ELECTRO-OPTICAL CHARACTERISTICS:







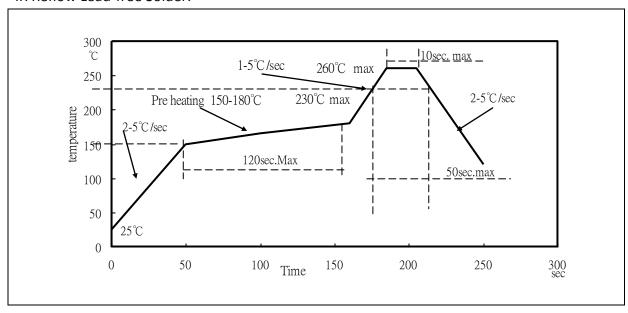






RECOMMENDED SOLDERING PROFILE:

IR Reflow Lead-free Solder:



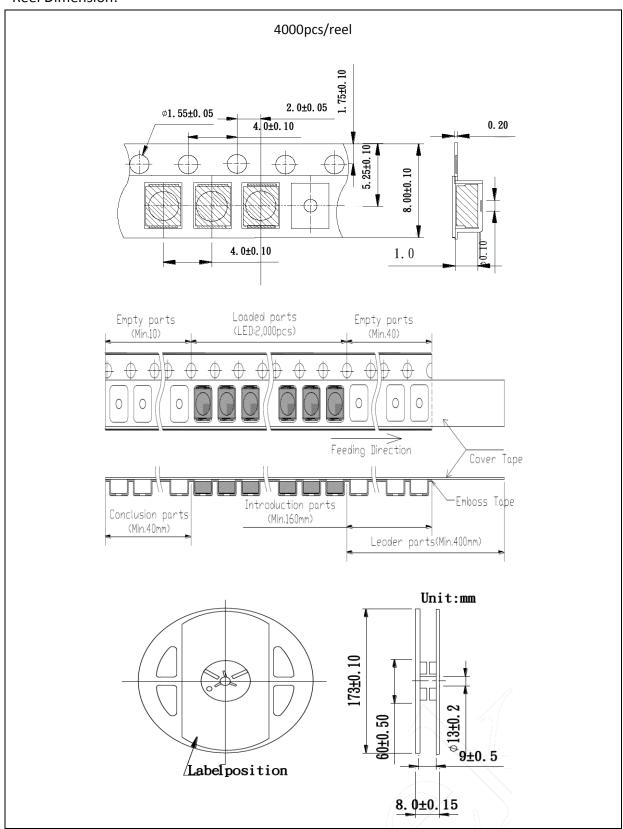
Note:

- 1. Maximum reflow soldering: 3 times.
- 2. Recommended reflow temperature: 240°C. Maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

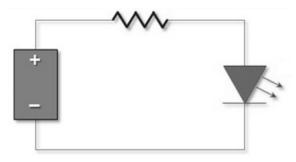
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	01/03/2016	Datasheet set-up.